

U.S. Patent Application N. 09/996,518
Reply to Office Action dated April 17, 2006

PATENT
450100-03654

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Katsuhiro Doi, et al.
Serial No. : 09/996,518
For : MOLDING DIE APPARATUS AND MOLDING METHOD
Filed : November 29, 2001
Examiner : Emmanuel S. Luk
Art Unit : 1722
Confirmation No. : 3535

RECEIVED
CENTRAL FAX CENTER

JUN 16 2006

OK to Enter
RCE
TR 7/10/06

745 Fifth Avenue
New York, NY 10151
(212) 588-0800

CERTIFICATE OF FACSIMILE

I hereby certify that this correspondence is being transmitted via
facsimile to (571) 273-8300 on June 16, 2006.

Bernie Shindman

(Name of person signing transmittal)



Signature

June 16, 2006

Date of Signature

AMENDMENT UNDER 37 C.F.R. §1.116

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action mailed on April 17, 2006, having a three-month statutory period for response set to expire on July 19, 2006 (July 17, 2006 being a Saturday), please amend the above-identified application as follows.